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### Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

### Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Obsolete
Core Processor	MPC8xx
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	50MHz
Co-Processors/DSP	Communications; CPM
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10Mbps (1)
SATA	-
USB	USB 1.x (1)
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 95°C (TA)
Security Features	-
Package / Case	256-BBGA
Supplier Device Package	256-PBGA (23x23)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc850cvr50bu">https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc850cvr50bu</a>

- Gate mode can enable/disable counting
- Interrupt can be masked on reference match and event capture
- Interrupts
  - Eight external interrupt request (IRQ) lines
  - Twelve port pins with interrupt capability
  - Fifteen internal interrupt sources
  - Programmable priority among SCCs and USB
  - Programmable highest-priority request
- Single socket PCMCIA-ATA interface
  - Master (socket) interface, release 2.1 compliant
  - Single PCMCIA socket
  - Supports eight memory or I/O windows
- Communications processor module (CPM)
  - 32-bit, Harvard architecture, scalar RISC communications processor (CP)
  - Protocol-specific command sets (for example, GRACEFUL STOP TRANSMIT stops transmission after the current frame is finished or immediately if no frame is being sent and CLOSE RXBD closes the receive buffer descriptor)
  - Supports continuous mode transmission and reception on all serial channels
  - Up to 8 Kbytes of dual-port RAM
  - Twenty serial DMA (SDMA) channels for the serial controllers, including eight for the four USB endpoints
  - Three parallel I/O registers with open-drain capability
- Four independent baud-rate generators (BRGs)
  - Can be connected to any SCC, SMC, or USB
  - Allow changes during operation
  - Autobaud support option
- Two SCCs (serial communications controllers)
  - Ethernet/IEEE 802.3, supporting full 10-Mbps operation
  - HDLC/SDLC™ (all channels supported at 2 Mbps)
  - HDLC bus (implements an HDLC-based local area network (LAN))
  - Asynchronous HDLC to support PPP (point-to-point protocol)
  - AppleTalk®
  - Universal asynchronous receiver transmitter (UART)
  - Synchronous UART
  - Serial infrared (IrDA)
  - Totally transparent (bit streams)
  - Totally transparent (frame based with optional cyclic redundancy check (CRC))

$\theta_{JA}$  = Package thermal resistance, junction to ambient, °C/W

$$P_D = P_{INT} + P_{I/O}$$

$$P_{INT} = I_{DD} \times V_{DD}, \text{ watts—chip internal power}$$

$P_{I/O}$  = Power dissipation on input and output pins—user determined

For most applications  $P_{I/O} < 0.3 \bullet P_{INT}$  and can be neglected. If  $P_{I/O}$  is neglected, an approximate relationship between  $P_D$  and  $T_J$  is:

$$P_D = K \div (T_J + 273^\circ\text{C})(2)$$

Solving equations (1) and (2) for K gives:

$$K = P_D \bullet (T_A + 273^\circ\text{C}) + \theta_{JA} \bullet P_D^2(3)$$

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring  $P_D$  (at equilibrium) for a known  $T_A$ . Using this value of K, the values of  $P_D$  and  $T_J$  can be obtained by solving equations (1) and (2) iteratively for any value of  $T_A$ .

## 5.1 Layout Practices

Each  $V_{CC}$  pin on the MPC850 should be provided with a low-impedance path to the board's supply. Each GND pin should likewise be provided with a low-impedance path to ground. The power supply pins drive distinct groups of logic on chip. The  $V_{CC}$  power supply should be bypassed to ground using at least four 0.1  $\mu\text{F}$  by-pass capacitors located as close as possible to the four sides of the package. The capacitor leads and associated printed circuit traces connecting to chip  $V_{CC}$  and GND should be kept to less than half an inch per capacitor lead. A four-layer board is recommended, employing two inner layers as  $V_{CC}$  and GND planes.

All output pins on the MPC850 have fast rise and fall times. Printed circuit (PC) trace interconnection length should be minimized in order to minimize undershoot and reflections caused by these fast output switching times. This recommendation particularly applies to the address and data busses. Maximum PC trace lengths of six inches are recommended. Capacitance calculations should consider all device loads as well as parasitic capacitances due to the PC traces. Attention to proper PCB layout and bypassing becomes especially critical in systems with higher capacitive loads because these loads create higher transient currents in the  $V_{CC}$  and GND circuits. Pull up all unused inputs or signals that will be inputs during reset. Special care should be taken to minimize the noise levels on the PLL supply pins.

## 6 Bus Signal Timing

Table 6 provides the bus operation timing for the MPC850 at 50 MHz, 66 MHz, and 80 MHz. Timing information for other bus speeds can be interpolated by equation using the MPC850 Electrical Specifications Spreadsheet found at <http://www.mot.com/netcomm>.

The maximum bus speed supported by the MPC850 is 50 MHz. Higher-speed parts must be operated in half-speed bus mode (for example, an MPC850 used at 66 MHz must be configured for a 33 MHz bus).

The timing for the MPC850 bus shown assumes a 50-pF load. This timing can be derated by 1 ns per 10 pF. Derating calculations can also be performed using the MPC850 Electrical Specifications Spreadsheet.

Table 6. Bus Operation Timing <sup>1</sup>

Num	Characteristic	50 MHz		66 MHz		80 MHz		FFACT	Cap Load (default 50 pF)	Unit
		Min	Max	Min	Max	Min	Max			
B1	CLKOUT period	20	—	30.30	—	25	—	—	—	ns
B1a	EXTCLK to CLKOUT phase skew (EXTCLK > 15 MHz and MF <= 2)	-0.90	0.90	-0.90	0.90	-0.90	0.90	—	50.00	ns
B1b	EXTCLK to CLKOUT phase skew (EXTCLK > 10 MHz and MF < 10)	-2.30	2.30	-2.30	2.30	-2.30	2.30	—	50.00	ns
B1c	CLKOUT phase jitter (EXTCLK > 15 MHz and MF <= 2) <sup>2</sup>	-0.60	0.60	-0.60	0.60	-0.60	0.60	—	50.00	ns
B1d	CLKOUT phase jitter <sup>2</sup>	-2.00	2.00	-2.00	2.00	-2.00	2.00	—	50.00	ns
B1e	CLKOUT frequency jitter (MF < 10) <sup>2</sup>	—	0.50	—	0.50	—	0.50	—	50.00	%
B1f	CLKOUT frequency jitter (10 < MF < 500) <sup>2</sup>	—	2.00	—	2.00	—	2.00	—	50.00	%
B1g	CLKOUT frequency jitter (MF > 500) <sup>2</sup>	—	3.00	—	3.00	—	3.00	—	50.00	%
B1h	Frequency jitter on EXTCLK <sup>3</sup>	—	0.50	—	0.50	—	0.50	—	50.00	%
B2	CLKOUT pulse width low	8.00	—	12.12	—	10.00	—	—	50.00	ns
B3	CLKOUT width high	8.00	—	12.12	—	10.00	—	—	50.00	ns
B4	CLKOUT rise time	—	4.00	—	4.00	—	4.00	—	50.00	ns
B5	CLKOUT fall time	—	4.00	—	4.00	—	4.00	—	50.00	ns
B7	CLKOUT to A[6–31], RD/WR, BURST, D[0–31], DP[0–3] invalid	5.00	—	7.58	—	6.25	—	0.250	50.00	ns
B7a	CLKOUT to TSIZ[0–1], REG, RSV, AT[0–3], BDIP, PTR invalid	5.00	—	7.58	—	6.25	—	0.250	50.00	ns
B7b	CLKOUT to BR, BG, FRZ, VFLS[0–1], VF[0–2] IWP[0–2], LWP[0–1], STS invalid <sup>4</sup>	5.00	—	7.58	—	6.25	—	0.250	50.00	ns
B8	CLKOUT to A[6–31], RD/WR, BURST, D[0–31], DP[0–3] valid	5.00	11.75	7.58	14.33	6.25	13.00	0.250	50.00	ns
B8a	CLKOUT to TSIZ[0–1], REG, RSV, AT[0–3] BDIP, PTR valid	5.00	11.75	7.58	14.33	6.25	13.00	0.250	50.00	ns
B8b	CLKOUT to BR, BG, VFLS[0–1], VF[0–2], IWP[0–2], FRZ, LWP[0–1], STS valid <sup>4</sup>	5.00	11.74	7.58	14.33	6.25	13.00	0.250	50.00	ns

Table 6. Bus Operation Timing <sup>1</sup> (continued)

Num	Characteristic	50 MHz		66 MHz		80 MHz		FFACT	Cap Load (default 50 pF)	Unit
		Min	Max	Min	Max	Min	Max			
B28c	CLKOUT falling edge to $\overline{\text{WE}}[0-3]$ negated GPCM write access TRLX = 0,1 CSNT = 1 write access TRLX = 0, CSNT = 1, EBDF = 1	7.00	14.00	11.00	18.00	9.00	16.00	0.375	50.00	ns
B28d	CLKOUT falling edge to $\overline{\text{CS}}$ negated GPCM write access TRLX = 0,1 CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1	—	14.00	—	18.00	—	16.00	0.375	50.00	ns
B29	$\overline{\text{WE}}[0-3]$ negated to D[0-31], DP[0-3] high-Z GPCM write access, CSNT = 0	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B29a	$\overline{\text{WE}}[0-3]$ negated to D[0-31], DP[0-3] high-Z GPCM write access, TRLX = 0 CSNT = 1, EBDF = 0	8.00	—	13.00	—	11.00	—	0.500	50.00	ns
B29b	$\overline{\text{CS}}$ negated to D[0-31], DP[0-3], high-Z GPCM write access, ACS = 00, TRLX = 0 & CSNT = 0	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B29c	$\overline{\text{CS}}$ negated to D[0-31], DP[0-3] high-Z GPCM write access, TRLX = 0, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 0	8.00	—	13.00	—	11.00	—	0.500	50.00	ns
B29d	$\overline{\text{WE}}[0-3]$ negated to D[0-31], DP[0-3] high-Z GPCM write access, TRLX = 1, CSNT = 1, EBDF = 0	28.00	—	43.00	—	36.00	—	1.500	50.00	ns
B29e	$\overline{\text{CS}}$ negated to D[0-31], DP[0-3] high-Z GPCM write access, TRLX = 1, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 0	28.00	—	43.00	—	36.00	—	1.500	50.00	ns
B29f	$\overline{\text{WE}}[0-3]$ negated to D[0-31], DP[0-3] high-Z GPCM write access TRLX = 0, CSNT = 1, EBDF = 1	5.00	—	9.00	—	7.00	—	0.375	50.00	ns
B29g	$\overline{\text{CS}}$ negated to D[0-31], DP[0-3] high-Z GPCM write access TRLX = 0, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1	5.00	—	9.00	—	7.00	—	0.375	50.00	ns

Table 6. Bus Operation Timing <sup>1</sup> (continued)

Num	Characteristic	50 MHz		66 MHz		80 MHz		FFACT	Cap Load (default 50 pF)	Unit
		Min	Max	Min	Max	Min	Max			
B29h	$\overline{WE}[0-3]$ negated to D[0-31], DP[0-3] high-Z GPCM write access TRLX = 0, CSNT = 1, EBDF = 1	25.00	—	39.00	—	31.00	—	1.375	50.00	ns
B29i	$\overline{CS}$ negated to D[0-31], DP[0-3] high-Z GPCM write access, TRLX = 1, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1	25.00	—	39.00	—	31.00	—	1.375	50.00	ns
B30	$\overline{CS}$ , $\overline{WE}[0-3]$ negated to A[6-31] invalid GPCM write access <sup>9</sup>	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B30a	$\overline{WE}[0-3]$ negated to A[6-31] invalid GPCM write access, TRLX = 0, CSNT = 1, $\overline{CS}$ negated to A[6-31] invalid GPCM write access TRLX = 0, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 0	8.00	—	13.00	—	11.00	—	0.500	50.00	ns
B30b	$\overline{WE}[0-3]$ negated to A[6-31] invalid GPCM write access, TRLX = 1, CSNT = 1, $\overline{CS}$ negated to A[6-31] Invalid GPCM write access TRLX = 1, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 0	28.00	—	43.00	—	36.00	—	1.500	50.00	ns
B30c	$\overline{WE}[0-3]$ negated to A[6-31] invalid GPCM write access, TRLX = 0, CSNT = 1, $\overline{CS}$ negated to A[6-31] invalid GPCM write access, TRLX = 0, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1	5.00	—	8.00	—	6.00	—	0.375	50.00	ns
B30d	$\overline{WE}[0-3]$ negated to A[6-31] invalid GPCM write access TRLX = 1, CSNT = 1, $\overline{CS}$ negated to A[6-31] invalid GPCM write access TRLX = 1, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1	25.00	—	39.00	—	31.00	—	1.375	50.00	ns

Table 6. Bus Operation Timing <sup>1</sup> (continued)

Num	Characteristic	50 MHz		66 MHz		80 MHz		FFACT	Cap Load (default 50 pF)	Unit
		Min	Max	Min	Max	Min	Max			
B33a	CLKOUT rising edge to GPL valid - as requested by control bit GxT3 in the corresponding word in the UPM	5.00	12.00	8.00	14.00	6.00	13.00	0.250	50.00	ns
B34	A[6–31] and D[0–31] to $\overline{CS}$ valid - as requested by control bit CST4 in the corresponding word in the UPM	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B34a	A[6–31] and D[0–31] to $\overline{CS}$ valid - as requested by control bit CST1 in the corresponding word in the UPM	8.00	—	13.00	—	11.00	—	0.500	50.00	ns
B34b	A[6–31] and D[0–31] to $\overline{CS}$ valid - as requested by CST2 in the corresponding word in UPM	13.00	—	21.00	—	17.00	—	0.750	50.00	ns
B35	A[6–31] to $\overline{CS}$ valid - as requested by control bit BST4 in the corresponding word in UPM	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B35a	A[6–31] and D[0–31] to $\overline{BS}$ valid - as requested by BST1 in the corresponding word in the UPM	8.00	—	13.00	—	11.00	—	0.500	50.00	ns
B35b	A[6–31] and D[0–31] to $\overline{BS}$ valid - as requested by control bit BST2 in the corresponding word in the UPM	13.00	—	21.00	—	17.00	—	0.750	50.00	ns
B36	A[6–31] and D[0–31] to GPL valid - as requested by control bit GxT4 in the corresponding word in the UPM	3.00	—	6.00	—	4.00	—	0.250	50.00	ns
B37	UPWAIT valid to CLKOUT falling edge <sup>10</sup>	6.00	—	6.00	—	6.00	—	—	50.00	ns
B38	CLKOUT falling edge to UPGATE valid <sup>10</sup>	1.00	—	1.00	—	1.00	—	—	50.00	ns
B39	$\overline{AS}$ valid to CLKOUT rising edge <sup>11</sup>	7.00	—	7.00	—	7.00	—	—	50.00	ns
B40	A[6–31], TSIZ[0–1], RD $\overline{WR}$ , BURST, valid to CLKOUT rising edge.	7.00	—	7.00	—	7.00	—	—	50.00	ns
B41	$\overline{TS}$ valid to CLKOUT rising edge (setup time)	7.00	—	7.00	—	7.00	—	—	50.00	ns

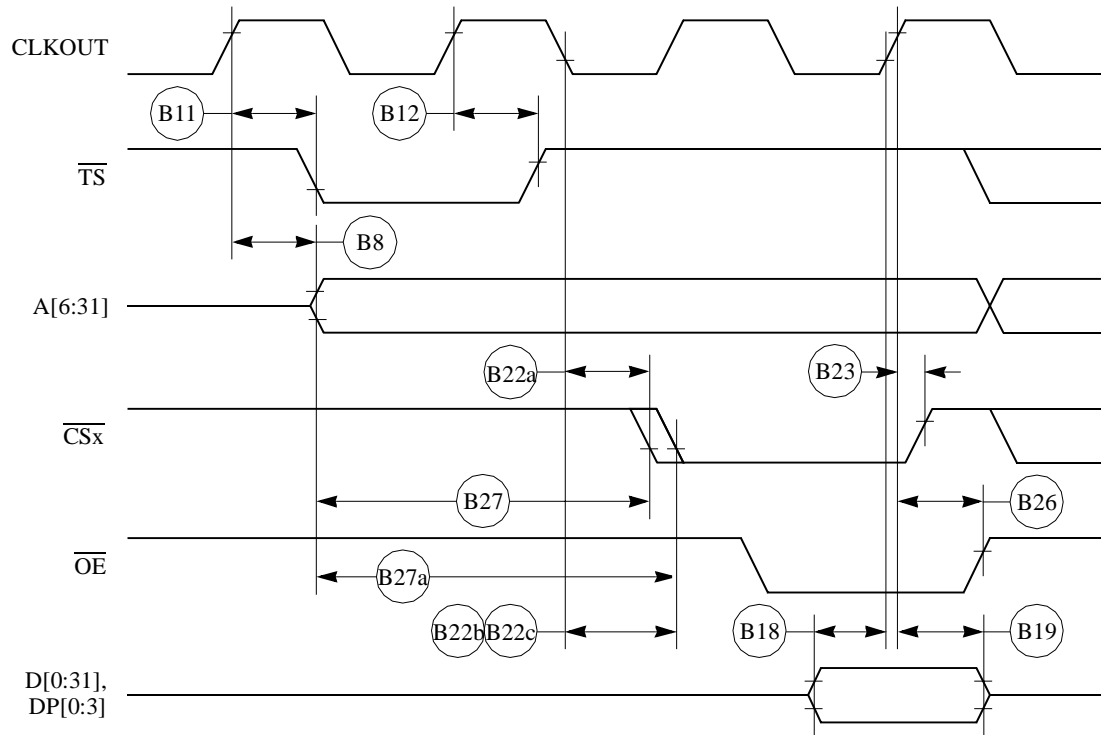
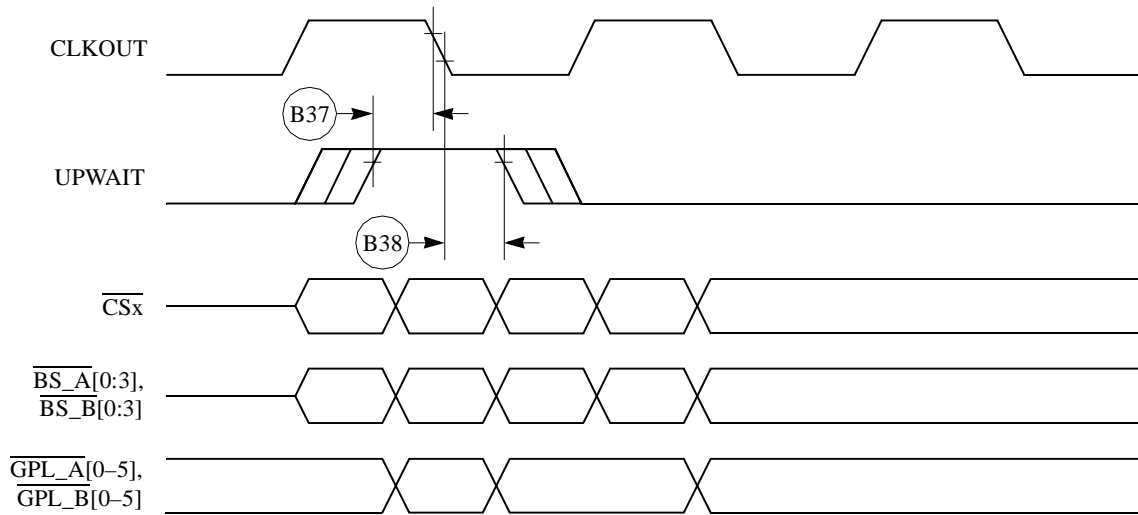


Figure 12. External Bus Read Timing (GPCM Controlled—TRLX = 1, ACS = 10, ACS = 11)

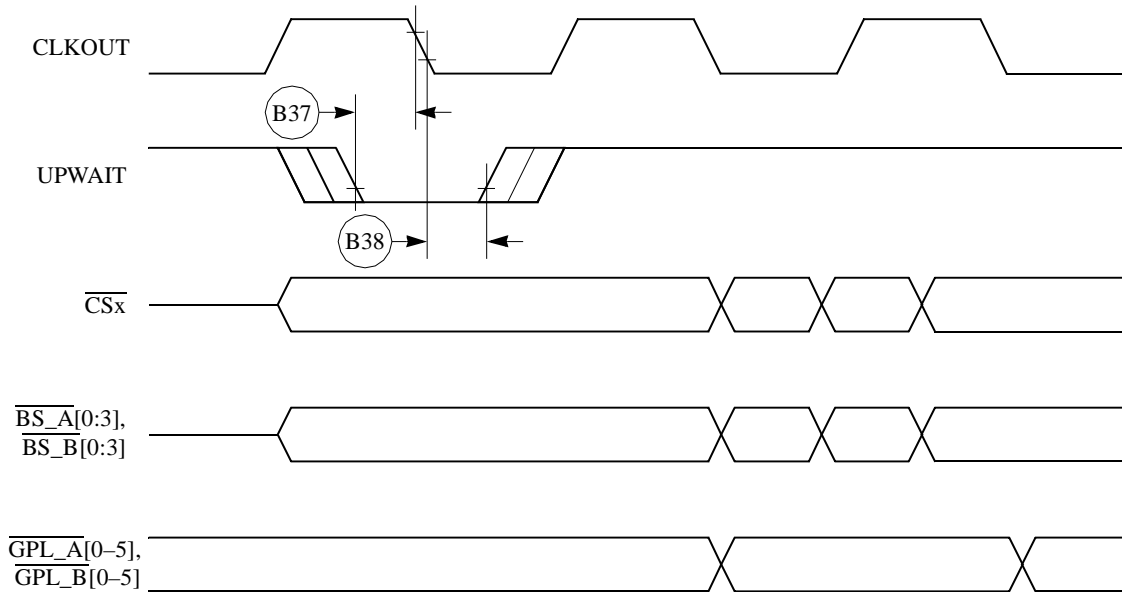


Figure 17 provides the timing for the asynchronous asserted UPWAIT signal controlled by the UPM.



**Figure 17. Asynchronous UPWAIT Asserted Detection in UPM Handled Cycles Timing**

Figure 18 provides the timing for the asynchronous negated UPWAIT signal controlled by the UPM.



**Figure 18. Asynchronous  $\overline{\text{UPWAIT}}$  Negated Detection in UPM Handled Cycles Timing**

Figure 24 provides the PCMCIA access cycle timing for the external bus read.

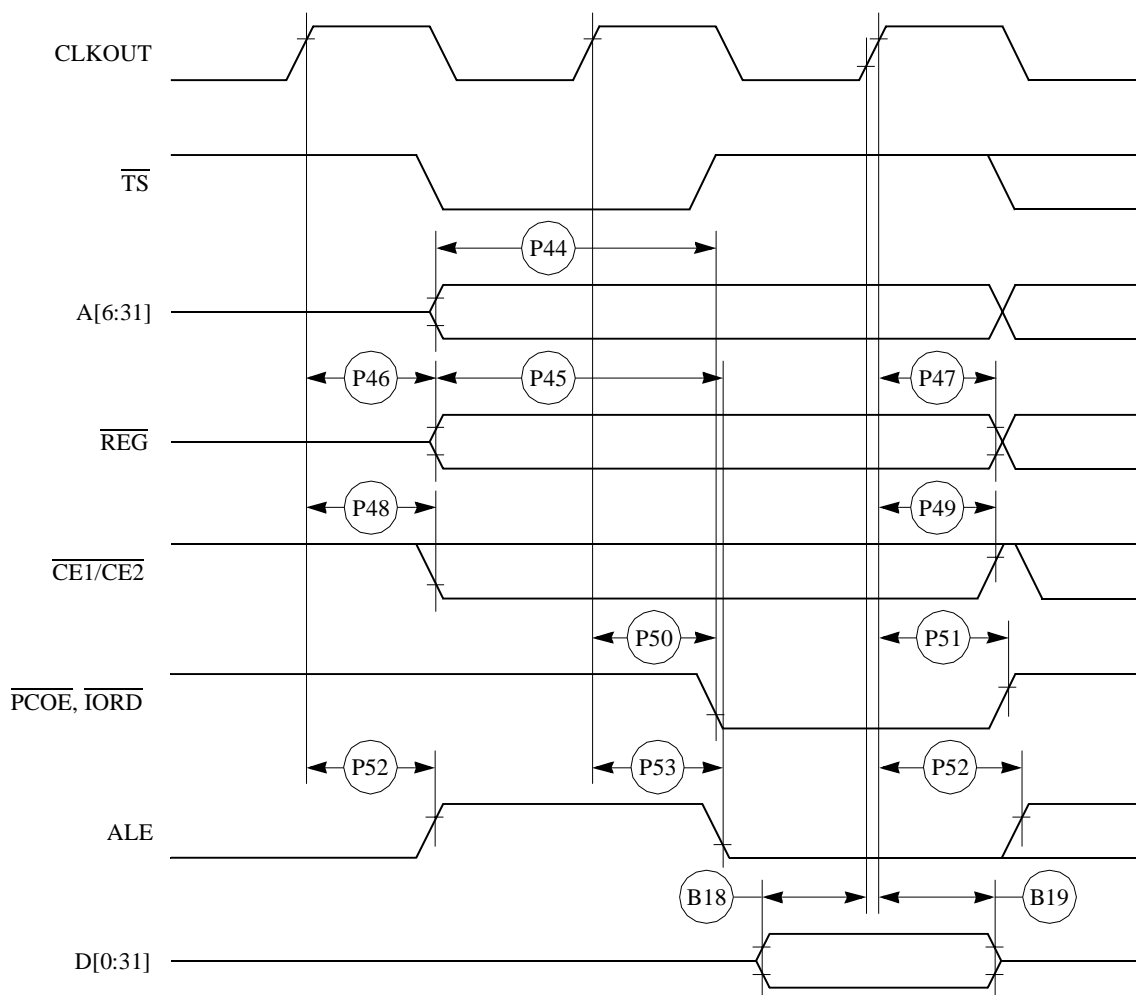


Figure 24. PCMCIA Access Cycles Timing External Bus Read

Figure 25 provides the PCMCIA access cycle timing for the external bus write.

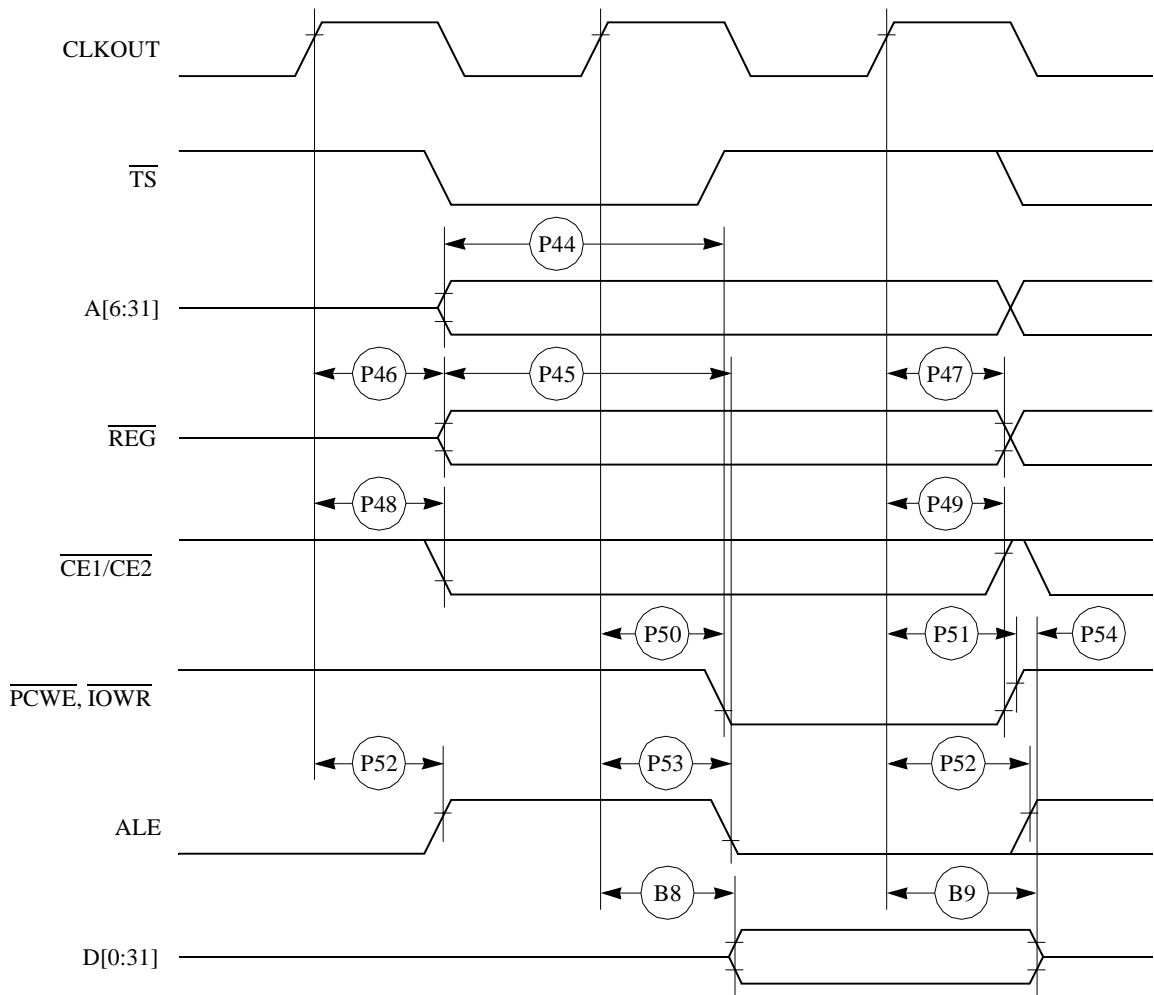


Figure 25. PCMCIA Access Cycles Timing External Bus Write

Figure 26 provides the PCMCIA WAIT signals detection timing.

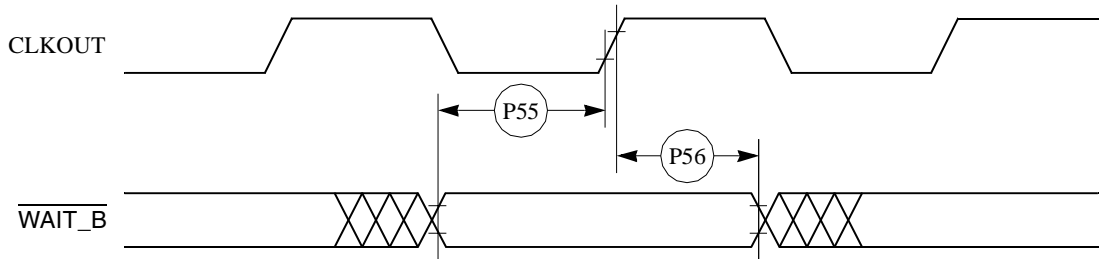


Figure 26. PCMCIA  $\overline{\text{WAIT}}$  Signal Detection Timing

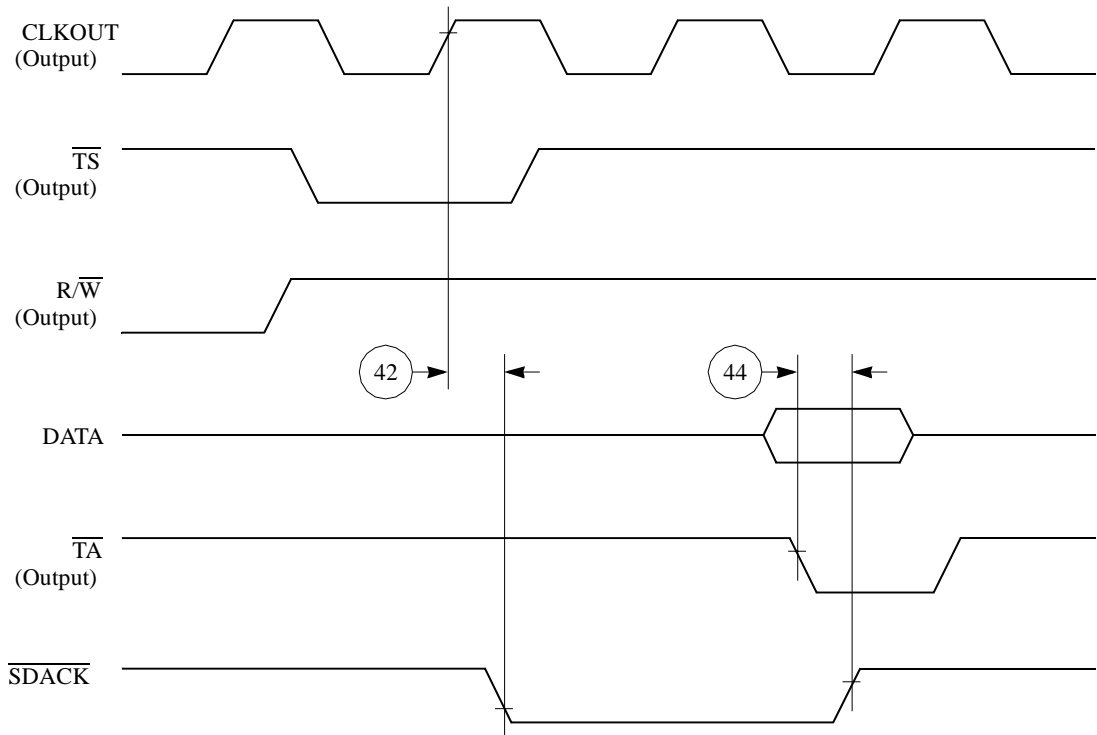


Figure 41.  $\overline{SDACK}$  Timing Diagram—Peripheral Write,  $\overline{TA}$  Sampled High at the Falling Edge of the Clock

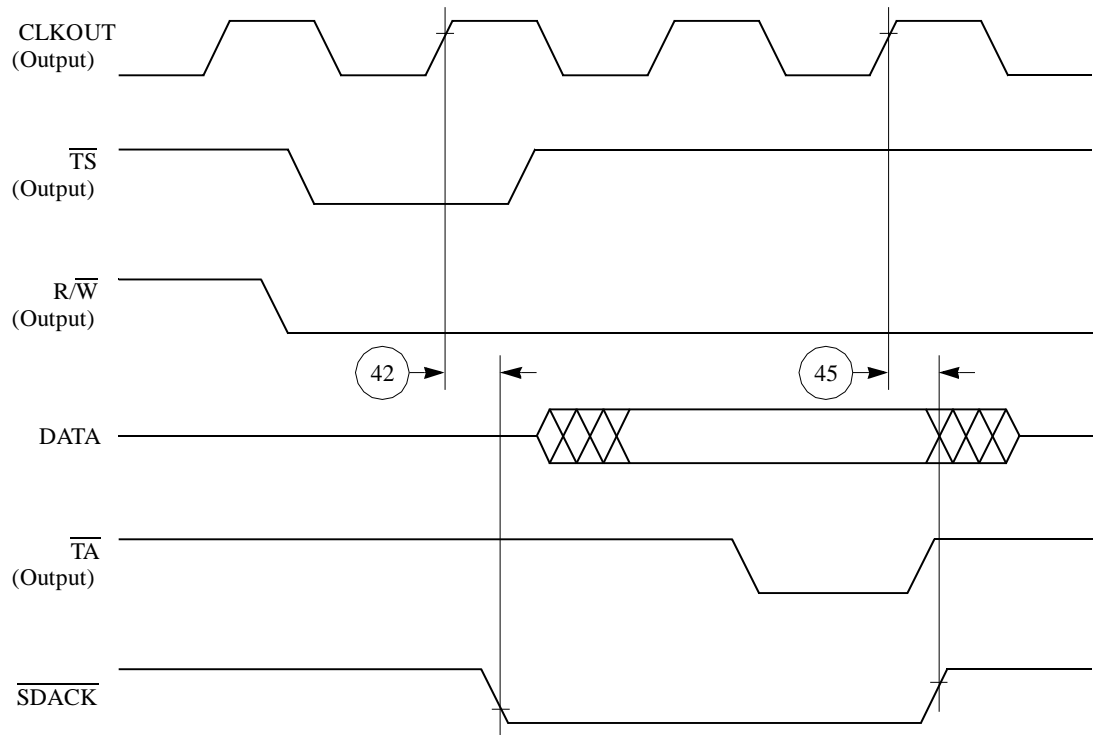


Figure 42.  $\overline{SDACK}$  Timing Diagram—Peripheral Read

## 8.6 SCC in NMSI Mode Electrical Specifications

Table 18 provides the NMSI external clock timing.

**Table 18. NMSI External Clock Timing**

Num	Characteristic	All Frequencies		Unit
		Min	Max	
100	RCLKx and TCLKx frequency <sup>1</sup> (x = 2, 3 for all specs in this table)	1/SYNCCLK	—	ns
101	RCLKx and TCLKx width low	1/SYNCCLK +5	—	ns
102	RCLKx and TCLKx rise/fall time	—	15.00	ns
103	TXDx active delay (from TCLKx falling edge)	0.00	50.00	ns
104	$\overline{\text{RTSx}}$ active/inactive delay (from TCLKx falling edge)	0.00	50.00	ns
105	$\overline{\text{CTSx}}$ setup time to TCLKx rising edge	5.00	—	ns
106	RXDx setup time to RCLKx rising edge	5.00	—	ns
107	RXDx hold time from RCLKx rising edge <sup>2</sup>	5.00	—	ns
108	$\overline{\text{CDx}}$ setup time to RCLKx rising edge	5.00	—	ns

<sup>1</sup> The ratios SyncCLK/RCLKx and SyncCLK/TCLKx must be greater than or equal to 2.25/1.

<sup>2</sup> Also applies to  $\overline{\text{CD}}$  and  $\overline{\text{CTS}}$  hold time when they are used as an external sync signal.

Table 19 provides the NMSI internal clock timing.

**Table 19. NMSI Internal Clock Timing**

Num	Characteristic	All Frequencies		Unit
		Min	Max	
100	RCLKx and TCLKx frequency <sup>1</sup> (x = 2, 3 for all specs in this table)	0.00	SYNCCLK/3	MHz
102	RCLKx and TCLKx rise/fall time	—	—	ns
103	TXDx active delay (from TCLKx falling edge)	0.00	30.00	ns
104	$\overline{\text{RTSx}}$ active/inactive delay (from TCLKx falling edge)	0.00	30.00	ns
105	$\overline{\text{CTSx}}$ setup time to TCLKx rising edge	40.00	—	ns
106	RXDx setup time to RCLKx rising edge	40.00	—	ns
107	RXDx hold time from RCLKx rising edge <sup>2</sup>	0.00	—	ns
108	$\overline{\text{CDx}}$ setup time to RCLKx rising edge	40.00	—	ns

<sup>1</sup> The ratios SyncCLK/RCLKx and SyncCLK/TCLK1x must be greater or equal to 3/1.

<sup>2</sup> Also applies to  $\overline{\text{CD}}$  and  $\overline{\text{CTS}}$  hold time when they are used as an external sync signals.

Figure 50 through Figure 52 show the NMSI timings.

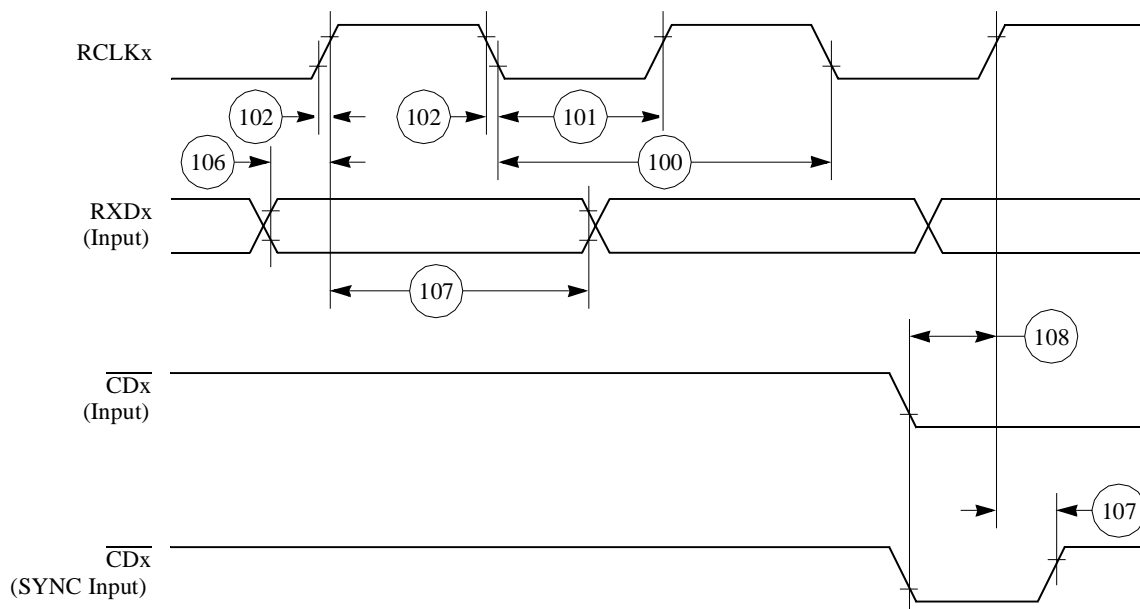


Figure 50. SCC NMSI Receive Timing Diagram

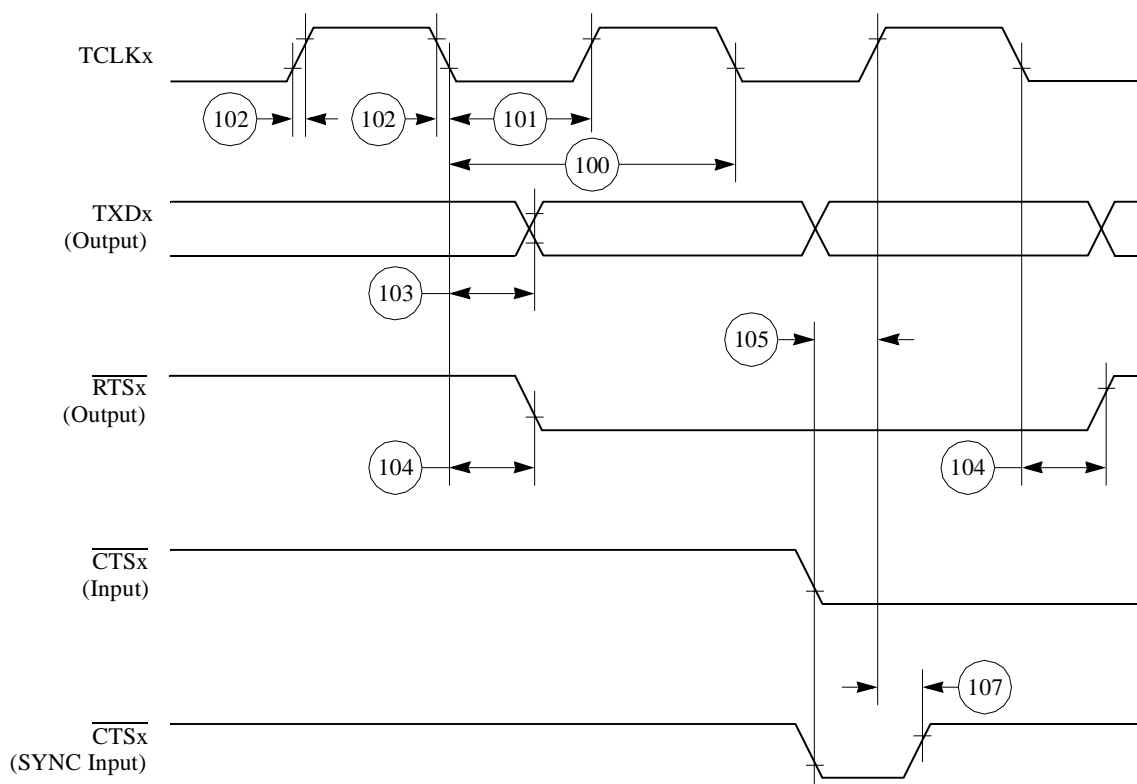


Figure 51. SCC NMSI Transmit Timing Diagram

Table 20. Ethernet Timing (continued)

Num	Characteristic	All Frequencies		Unit
		Min	Max	
134	TENA inactive delay (from TCLKx rising edge)	10.00	50.00	ns
138	CLKOUT low to $\overline{\text{SDACK}}$ asserted <sup>2</sup>	—	20.00	ns
139	CLKOUT low to $\overline{\text{SDACK}}$ negated <sup>2</sup>	—	20.00	ns

<sup>1</sup> The ratios SyncCLK/RCLKx and SyncCLK/TCLKx must be greater or equal to 2/1.

<sup>2</sup>  $\overline{\text{SDACK}}$  is asserted whenever the SDMA writes the incoming frame destination address into memory.

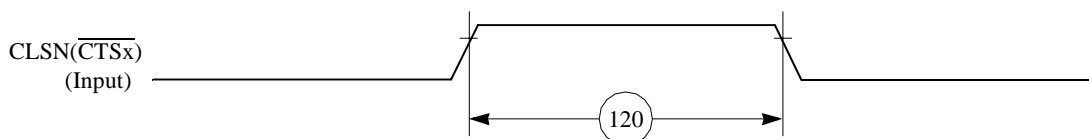


Figure 53. Ethernet Collision Timing Diagram

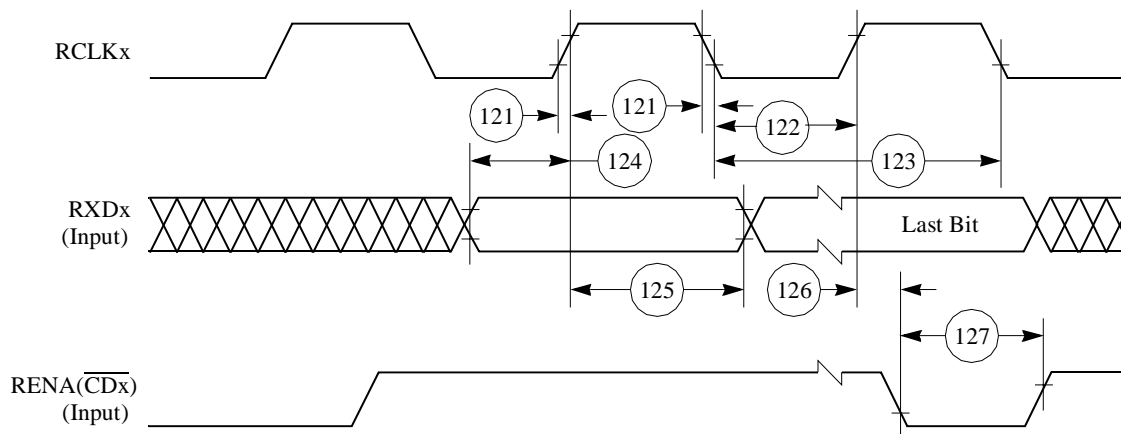
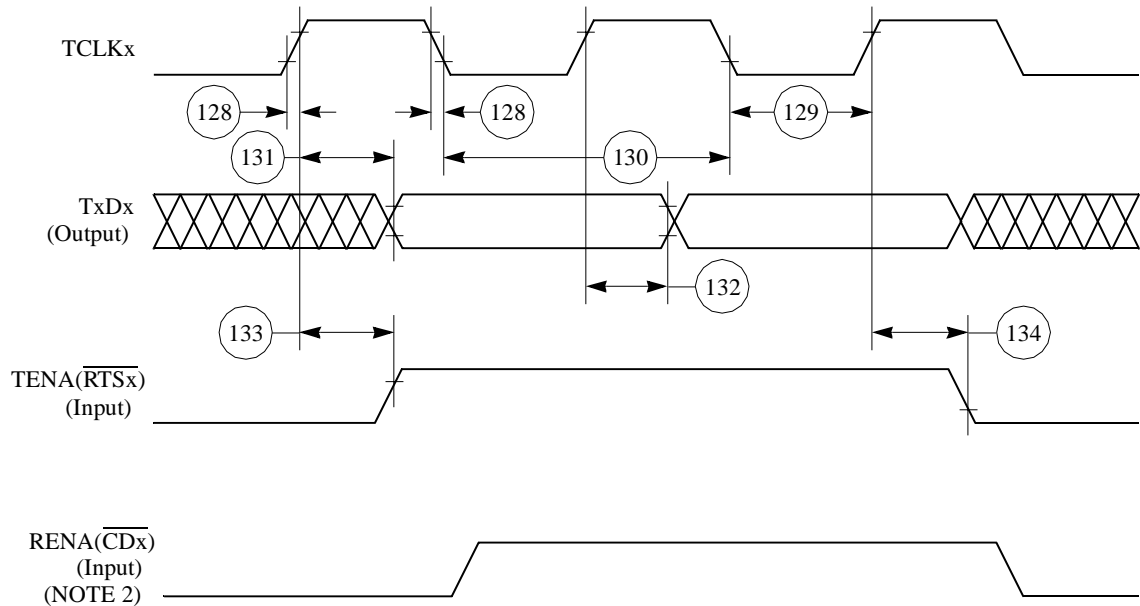


Figure 54. Ethernet Receive Timing Diagram



- NOTES:
1. Transmit clock invert (TCI) bit in GSMR is set.
  2. If RENA is deasserted before TENA, or RENA is not asserted at all during transmit, then the CSL bit is set in the buffer descriptor at the end of the frame transmission.

Figure 55. Ethernet Transmit Timing Diagram

## 8.8 SMC Transparent AC Electrical Specifications

Figure 21 provides the SMC transparent timings as shown in Figure 56.

Table 21. Serial Management Controller Timing

Num	Characteristic	All Frequencies		Unit
		Min	Max	
150	SMCLKx clock period <sup>1</sup>	100.00	—	ns
151	SMCLKx width low	50.00	—	ns
151a	SMCLKx width high	50.00	—	ns
152	SMCLKx rise/fall time	—	15.00	ns
153	SMTXDx active delay (from SMCLKx falling edge)	10.00	50.00	ns
154	SMRXDx/SMSYNx setup time	20.00	—	ns
155	SMRXDx/SMSYNx hold time	5.00	—	ns

<sup>1</sup> The ratio SyncCLK/SMCLKx must be greater or equal to 2/1.



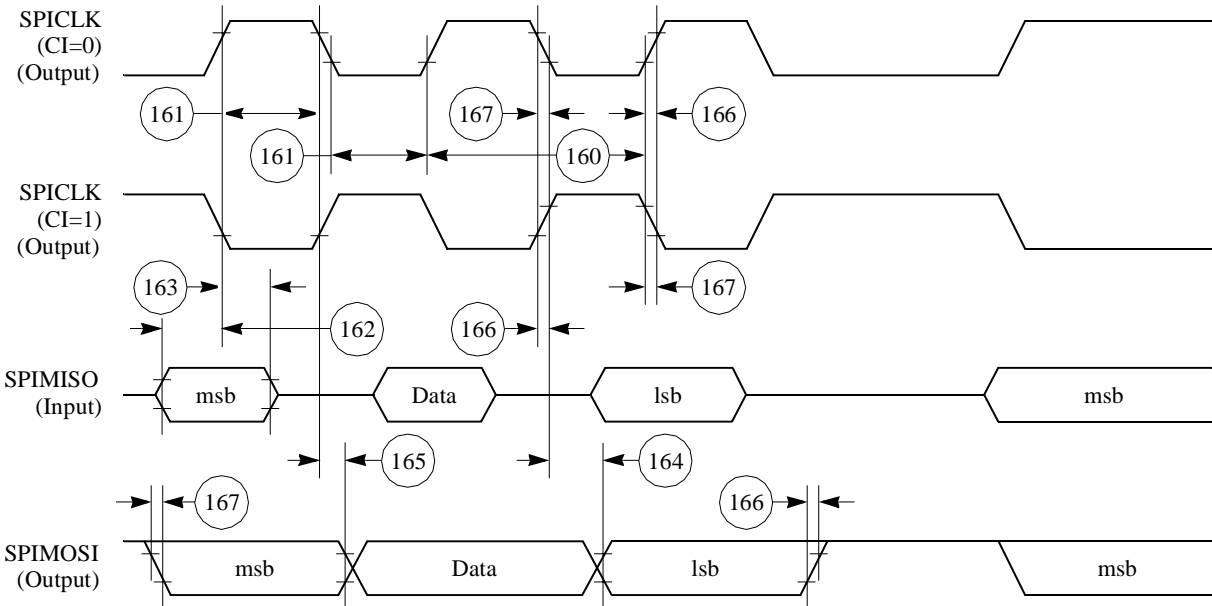


Figure 57. SPI Master (CP = 0) Timing Diagram

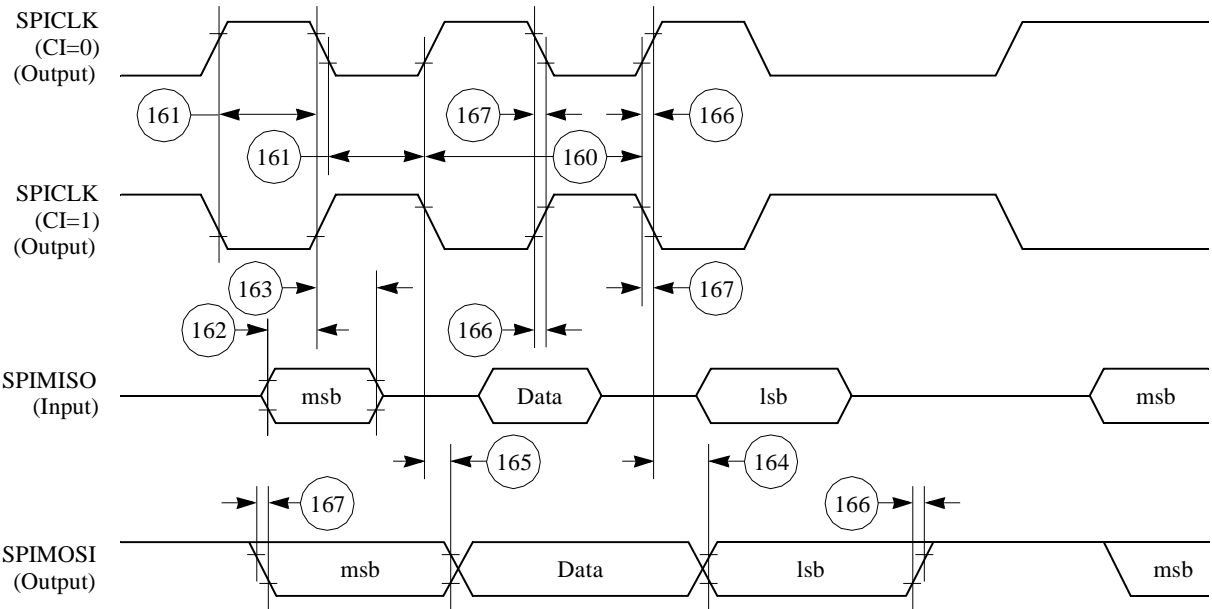


Figure 58. SPI Master (CP = 1) Timing Diagram

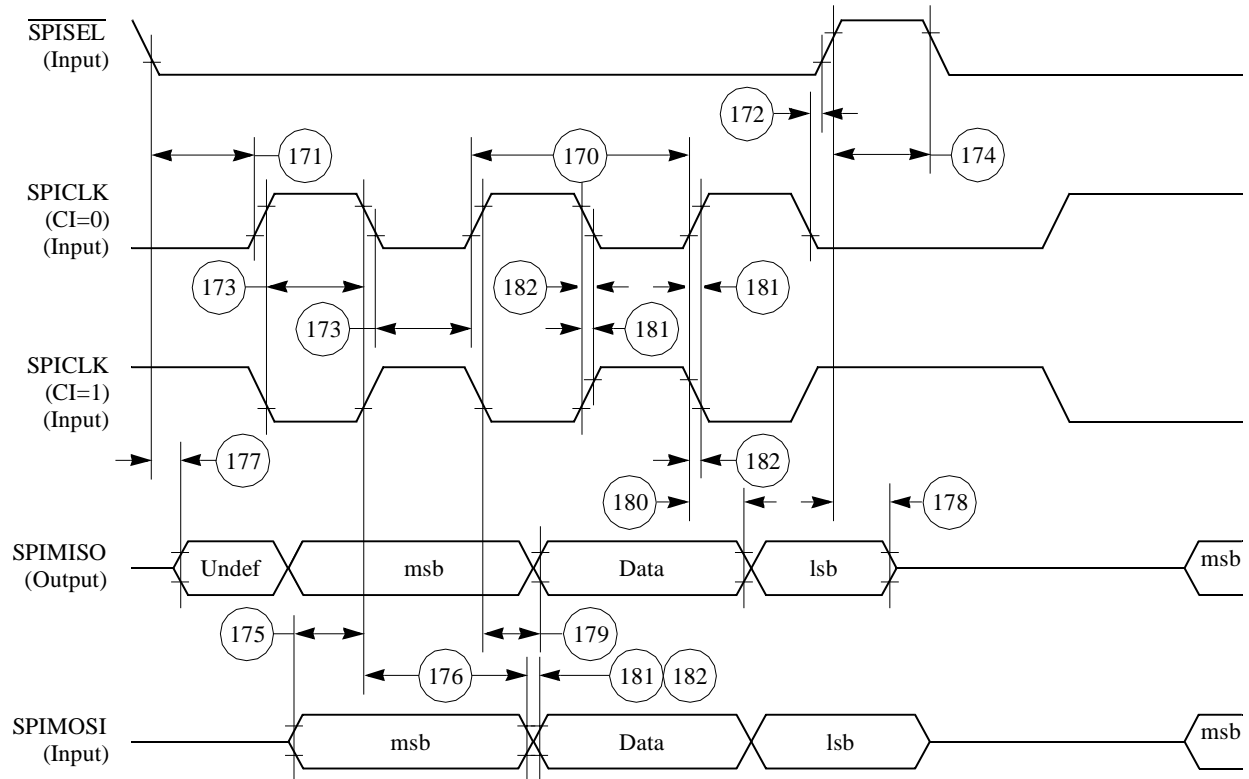


Figure 60. SPI Slave (CP = 1) Timing Diagram

## 8.11 I<sup>2</sup>C AC Electrical Specifications

Table 24 provides the I<sup>2</sup>C (SCL < 100 KHz) timings.

Table 24. I<sup>2</sup>C Timing (SCL < 100 KHz)

Num	Characteristic	All Frequencies		Unit
		Min	Max	
200	SCL clock frequency (slave)	0.00	100.00	KHz
200	SCL clock frequency (master) <sup>1</sup>	1.50	100.00	KHz
202	Bus free time between transmissions	4.70	—	μs
203	Low period of SCL	4.70	—	μs
204	High period of SCL	4.00	—	μs
205	Start condition setup time	4.70	—	μs
206	Start condition hold time	4.00	—	μs
207	Data hold time	0.00	—	μs
208	Data setup time	250.00	—	ns
209	SDL/SCL rise time	—	1.00	μs

# 10 Document Revision History

Table 28 lists significant changes between revisions of this document.

**Table 28. Document Revision History**

Revision	Date	Change
2	7/2005	Added footnote 3 to Table 5 (previously Table 4.5) and deleted IOL limit.
1	10/2002	Added MPC850DSL. Corrected Figure 25 on page 34.
0.2	04/2002	Updated power numbers and added Rev. C
0.1	11/2001	Removed reference to 5 Volt tolerance capability on peripheral interface pins. Replaced SI and IDL timing diagrams with better images. Updated to new template, added this revision table.

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